

ESCC (4001/023 Qualified R Failure Rate High Precision (10 ppm/°C, 0.05 %) Thin Film Chip Resistors



Vishay Sfernice Thin Film division holds ESCC QML qualification (ESCC technology flow qualification).

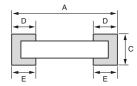
These HiRel components are ideal for low noise and precision applications, superior stability, low temperature coefficient of resistance, and low voltage coefficient, Vishay Sfernice's precision thin film wraparound resistors exceed requirements of MIL-PRF-55342G characteristics Y (± 10 ppm/°C).

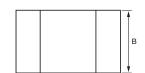
FEATURES

HALOGEN FREE

- Load life stability at ± 70 °C for 2000 h: 0.25 % under Pn
- Temperature coefficient to: 10 ppm/°C
- Very low noise (< 35 dB) and voltage coefficient (< 0.01 ppm/V)
- Resistance range: 100 Ω to 3.01 M Ω (depending on size)
- Tolerances down to 0.05 %
- SnPb terminations over nickel barrier
- ESCC 4001 (generic specifications)
- ESCC 4001/023 (detailed spececifications)
- ESCC qualified
- R failure rate (0.01 % per 1000 h)
- SMD wraparound chip resistor
- Halogen-free according to IEC 61249-2-21 definition

DIMENSIONS



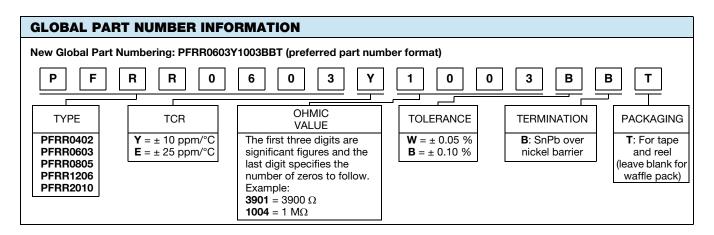


VADIANT	STYLE	DIMENSIONS in millimeters							
VARIANT NUMBER		Α		В		С		D	
NONDER		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
01, 05, 09	0603	1.39	2.16	0.62	1.01	0.25	1.02	0.25	0.51
02, 06, 10	0805	1.78	2.55	1.14	1.53	0.25	1.02	0.25	0.51
03, 07, 11	1206	2.87	3.64	1.47	1.86	0.25	1.02	0.25	0.51
04, 08, 12	2010	4.95	5.72	2.41	2.8	0.25	1.02	0.35	0.85
13, 14, 15	0402	0.87	1.64	0.47	0.86	0.25	1.02	0.12	0.38

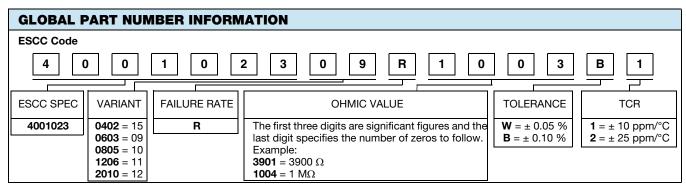
END OF PRODUCTION TESTING

Mandatory testing performed at the end of the production process:

• 100 % overload: Voltage $\sqrt{(6.25 P_n \times R_n)}$ or 2 U_L whichever is less - duration 2 s







Vishay Sfernice thin film is the first passive manufacturer to hold the ESCC Technology Flow Qualification, official certificate is available on ESCIES web site https://escies.org/ReadArticle?docld=727).

This qualification open the door to a new concept at ESA: The Failure Rate option (similar to the one offered in the MIL system), for instance R failure rate: 0.01 % per 1000 h.

New specifications describing this new concept have been released by the ESA:

2544001: Requirements for the Technology Flow Qualification of Film Resistors

https://escies.org/escc/specifications/2544001.pdf

26000: Failure Rate Level Sampling Plans and Procedures https://escies.org/escc/specifications/26000.pdf

21300: Terms, Definitions, Abbreviations, Symbols and Units https://escies.org/escc/specifications/21300.pdf

21700: General Requirements for the Marking of the ESCC Components

https://escies.org/escc/specifications/21700.pdf

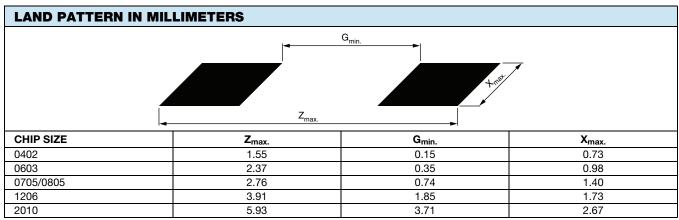
4001: Generic Specification Resistors Fixed Film https://escies.org/escc/specifications/4001.pdf

4001023: Resistors, Fixed, Chip, Thin Film, Type PHR and PFRR

https://escies.org/escc/specifications/4001023.pdf

Parts are delivered with space C.O.C.

Parts undergo 100 % overload at end of production process.



Note

Suggested land pattern: According to IPC-7351

STANDARD ELECTRICAL SPECIFICATIONS								
VISHAY SFERNICE DESIGNATION	PFRR 0402 @	PFRR 0603 🕝	PFRR 0805 @	PFRR 1206 🕝	PFRR 2010 @			
ESA specification applied								
Variant number	15	09	10	11	12			
Power rating at + 70 °C (P _n)	0.05 W	0.1 W	0.125 W	0.25 W	0.50 W			
Limiting element voltage (U _L)	30 V	50 V	100 V	150 V	200 V			
Ohmic value range	Min. 100 Ω Max. 150 kΩ	Min. 100 Ω Max. 261 kΩ	Min. 100 Ω Max. 301 kΩ	Min. 100 Ω Max. 1 MΩ	Min. 100 Ω Max. 3.01 MΩ			
Insulation voltage (Ui)	50 V	100 V	200 V	300 V	300 V			
Temperature coefficient	± 10 ppm/°C; ± 25 ppm/°C							
Tolerance		± 0.05 %, ± 0.1 %						
Temperature range	- 55 °C to + 155 °C							
Soldering temperature (T _{sol})	Soldering temperature (T _{sol}) 260 °C, immersion 10 s							



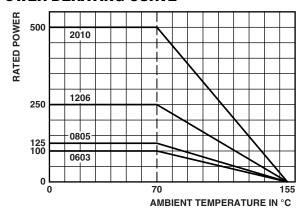
MECHANICAL SPECIFICATIONS				
Substrate material	Alumina			
Technology	Thin Film			
Film	Nickel Chromium with mineral passivation			
Protection	Epoxy and Silicon			
Terminations	B type: SnPb over nickel barrier for solder reflow			

PACKAGING

Two types of packaging are available: waffle-pack and tape and reel.

	NUMBER O			
SIZE	WAFFLE	TAPE AND REEL		TAPE WIDTH
	PACK 2" × 2"	MIN.	MAX.	WIDIR
0402			5000	
0603	100		5000	
0805		100		8 mm
1206	140		4000	
2010	60			

POWER DERATING CURVE



EXTENDED FEATURES

You may consult Vishay Sfernice for chip sizes, ohmic values and tolerances outside of the qualified range.

PERFORMANCE						
TEST	CONDITIONS	REQUIREME	TYPICAL			
IESI	CONDITIONS	ESA/SCC 4001/023	MIL-PRF-55342G	ITPICAL		
Short time overload	$U = \sqrt{(6.25 P_{\rm n} \times R_{\rm n})}$ $U_{\rm max.} < 2 U_{\rm L} - 2 {\rm s}$	$\pm 0.05 \% + (0.05 \Omega \times 100/R_{\rm n})$	0.10 %	± 0.01 %		
Rapid temperature change	- 55 °C/+ 155 °C 5 cycles CEI 66-2-14 Test Na	$\pm 0.05 \% + (0.05 \Omega \times 100/R_{\rm n})$	0.1 % (for 100 cycles)	± 0.01 % ± 0.015 % (for 500 cycles)		
Soldering (thermal shock)	260 °C/10 s CEI 68-2-20 A Test T6 (met. 1A)	$\pm 0.05 \% + (0.05 \Omega \times 100/R_{\rm n})$	-	± 0.005 %		
Terminal strength: Adhesion bend strength of end plated facing	CEI 115-1 Clause 4.32 CEI 115-1 Clause 4.33	$\pm 0.05 \% + (0.05 \Omega \times 100/R_n)$	-	± 0.01 %		
Climatic sequence	CEI 67-2-1/CEI 68-2-2 CEI 67-2-13/CEI 68-2-30	$\pm 0.10 \% + (0.05 \Omega \times 100/R_{\rm n})$	-	$\pm~0.02~\%$ Insulation resistance > 1 G Ω		
2000 h P _n at + 70 °C Load life 90'/30' cycle 8000 h		$\pm 0.25 \% + (0.05 \Omega \times 100/R_n)$ 1 % + (0.05 \Omega \times 100/R_n)	0.5 %	\pm 0.05 % (8000 h) Insulation resistance > 1 G Ω		
High temperature exposure	2000 h <i>P</i> _n at + 155 °C CEI 68-2-20A Test B	$\pm 0.15 \% + (0.05 \Omega \times 100/R_{\rm n})$	± 0.10 % (duration 1000 h)	$\pm~0.05~\%$ Insulation resistance > 1 G Ω		



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Vishay

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